

Converter - Brake - Inverter Module (CBI 1)

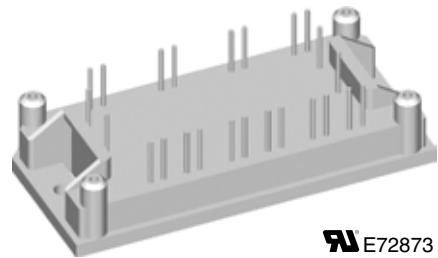
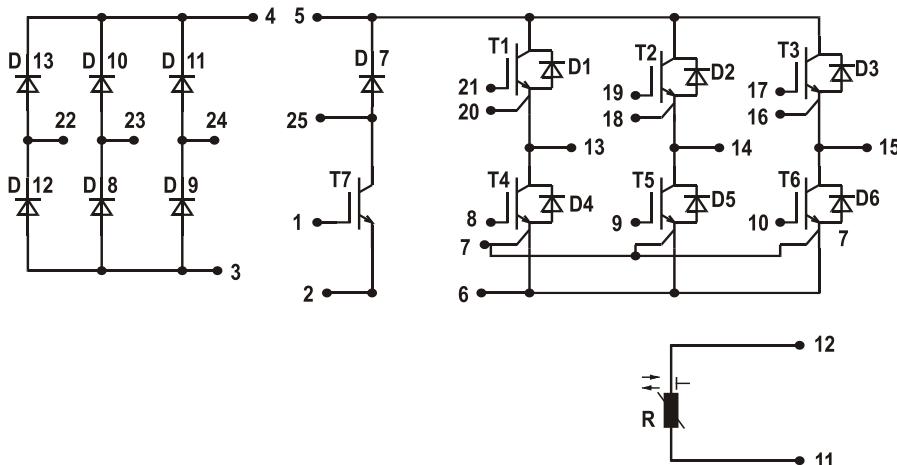
NPT IGBT

Preliminary data

Part name (Marking on product)

MUBW20-06A6K

Three Phase Rectifier	Brake Chopper	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 600 \text{ V}$	$V_{CES} = 600 \text{ V}$
$I_{DAVM25} = 95 \text{ A}$	$I_{C25} = 12 \text{ A}$	$I_{C25} = 25 \text{ A}$
$I_{FSM} = 250 \text{ A}$	$V_{CE(sat)} = 2.25 \text{ V}$	$V_{CE(sat)} = 2.0 \text{ V}$



E72873

Pin configuration see outlines.

Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Inverter with NPT IGBTs
- low saturation voltage
- positive temperature coefficient
- fast switching
- short tail current
- Epitaxial free wheeling diodes with hiperfast and soft reverse recovery
- Industry standard package with insulated copper base plate and soldering pins for PCB mounting
- Temperature sense included

Application:

- AC motor drives with
- Input from single or three phase grid
- Three phase synchronous or asynchronous motor
- Electric braking operation

Package:

- UL registered
- Industry standard E1-pack

Output Inverter T1 - T6

Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{CES}	collector emitter voltage	$T_{VJ} = 25^\circ\text{C}$ to 150°C		600		V
V_{GES}	max. DC gate voltage	continuous		± 20		V
V_{GEM}	max. transient collector gate voltage	transient		± 30		V
I_{C25}	collector current	$T_C = 25^\circ\text{C}$	25			A
I_{C80}		$T_C = 80^\circ\text{C}$	17			A
P_{tot}	total power dissipation	$T_C = 25^\circ\text{C}$	85			W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 15 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.0 2.3	2.4	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.4 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	4.5	6.5	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.6	mA
I_{GES}	gate emitter leakage current	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$		100		nA
C_{ies}	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$	800			pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 300 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 15 \text{ A}$	57			nC
$t_{d(on)}$	turn-on delay time	$\left. \begin{array}{l} \text{inductive load} \\ V_{CE} = 300 \text{ V}; I_C = 15 \text{ A} \\ V_{GE} = \pm 15 \text{ V}; R_{G(on)} = 39 \Omega \\ R_{G(off)} = 22 \Omega \end{array} \right\} T_{VJ} = 125^\circ\text{C}$	30			ns
t_r	current rise time		25			ns
$t_{d(off)}$	turn-off delay time		160			ns
t_f	current fall time		50			ns
E_{on}	turn-on energy per pulse		0.42			mJ
E_{off}	turn-off energy per pulse		0.44			mJ
I_{CM}	reverse bias safe operating area	$RBSOA; V_{GE} = \pm 15 \text{ V}; R_G = 68 \Omega$ $L = 100 \mu\text{H}; \text{clamped induct. load}$ $V_{CEmax} = V_{CES} - L_s \cdot di/dt$	30			A
t_{sc} (SCSOA)	short circuit safe operating area	$V_{CE} = 600 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 68 \Omega; \text{non-repetitive}$	10			μs
R_{thJC}	thermal resistance junction to case	(per IGBT)			1.5	K/W
R_{thCH}	thermal resistance case to heatsink	(per IGBT)	0.55			K/W

Output Inverter D1 - D6

Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$		600		V
I_{F25}	forward current	$T_C = 25^\circ\text{C}$		36		A
I_{F80}		$T_C = 80^\circ\text{C}$		24		A
V_F	forward voltage	$I_F = 15 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.5	2.1	V
I_{RM}	max. reverse recovery current	$\left. \begin{array}{l} V_R = 300 \text{ V} \\ di_F/dt = -400 \text{ A}/\mu\text{s} \\ I_F = 15 \text{ A}; V_{GE} = 0 \text{ V} \end{array} \right\} T_{VJ} = 100^\circ\text{C}$		14		A
t_{rr}	reverse recovery time			80		ns
$E_{rec(off)}$	reverse recovery energy			tbd		μJ
R_{thJC}	thermal resistance junction to case	(per diode)			1.6	K/W
R_{thCH}	thermal resistance case to heatsink	(per diode)	0.55			K/W

 $T_C = 25^\circ\text{C}$ unless otherwise stated

Brake Chopper T7

Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{CES}	collector emitter voltage	$T_{VJ} = 25^\circ\text{C}$ to 150°C			600	V
V_{GES}	max. DC gate voltage	continuous			± 20	V
V_{GEM}	max. transient collector gate voltage	transient			± 30	V
I_{C25}	collector current	$T_C = 25^\circ\text{C}$			11	A
I_{C80}		$T_C = 80^\circ\text{C}$			8	A
P_{tot}	total power dissipation	$T_C = 25^\circ\text{C}$			50	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 10 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	2.65	3.3	V
			$T_{VJ} = 125^\circ\text{C}$	3.1		V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.2 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	4.5		V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$		0.1	mA
			$T_{VJ} = 125^\circ\text{C}$		0.7	mA
I_{GES}	gate emitter leakage current	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$			120	nA
C_{ies}	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		220		pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 300 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 6 \text{ A}$		32		nC
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ\text{C}$		20		ns
t_r	current rise time			10		ns
$t_{d(off)}$	turn-off delay time			110		ns
t_f	current fall time			30		ns
E_{on}	turn-on energy per pulse			0.21		mJ
E_{off}	turn-off energy per pulse			0.26		mJ
I_{CM}	reverse bias safe operating area	$RBSOA; V_{GE} = \pm 15 \text{ V}; R_G = 54 \Omega$ $L = 100 \mu\text{H}; \text{clamped induct. load}$ $V_{CEmax} = V_{CES} - L \cdot di/dt$	$T_{VJ} = 125^\circ\text{C}$	18		A
t_{sc} (SCSOA)	short circuit safe operating area	$V_{CE} = 600 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 54 \Omega; \text{non-repetitive}$	$T_{VJ} = 125^\circ\text{C}$	10		μs
R_{thJC}	thermal resistance junction to case	(per IGBT)			2.75	K/W
R_{thCH}	thermal resistance case to heatsink	(per IGBT)		0.9		K/W

Brake Chopper D7

Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$			600	V
I_{F25}	forward current	$T_C = 25^\circ\text{C}$			21	A
I_{F80}		$T_C = 80^\circ\text{C}$			14	A
V_F	forward voltage	$I_F = 10 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	2.1	V	
			$T_{VJ} = 125^\circ\text{C}$	1.25	V	
I_R	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$		0.06	mA
			$T_{VJ} = 125^\circ\text{C}$	0.2	mA	
I_{RM}	max. reverse recovery current	$V_R = 100 \text{ V}; I_F = 12 \text{ A}$		3.5		A
t_{rr}	reverse recovery time		$di_F/dt = -100 \text{ A}/\mu\text{s}$	80		ns
$T_{VJ} = 100^\circ\text{C}$						
R_{thJC}	thermal resistance junction to case	(per diode)			2.5	K/W
R_{thCH}	thermal resistance case to heatsink	(per diode)		0.85		K/W

 $T_C = 25^\circ\text{C}$ unless otherwise stated

Input Rectifier Bridge D8 - D13

Symbol	Definitions	Conditions	Maximum Ratings		
V_{RRM}	max. repetitive reverse voltage		1600		V
I_{FAV}	average forward current	sine 180°	$T_c = 80^\circ\text{C}$	23	A
I_{DAVM}	max. average DC output current	rectangular; $d = 1/3$; bridge	$T_c = 80^\circ\text{C}$	65	A
I_{FSM}	max. surge forward current	$t = 10 \text{ ms}; \text{sine } 50 \text{ Hz}$	$T_c = 25^\circ\text{C}$	250	A
P_{tot}	total power dissipation		$T_c = 25^\circ\text{C}$	65	W

Symbol	Conditions	Characteristic Values				
		min.	typ.	max.		
V_F	forward voltage	$I_F = 30 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.1 1.2	1.45	V
I_R	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.4	0.02	mA
R_{thJC}	thermal resistance junction to case	(per diode)	$T_{VJ} = 25^\circ\text{C}$		1.9	K/W
R_{thCH}	thermal resistance case to heatsink	(per diode)		0.65		K/W

Temperature Sensor NTC

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	
R_{25}	resistance		$T_c = 25^\circ\text{C}$	4.45	4.7	$\text{k}\Omega$
$B_{25/85}$				3510	5.0	K

Module

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	
T_{VJ}	operating temperature		-40		125	$^\circ\text{C}$
T_{VJM}	max. virtual junction temperature				150	$^\circ\text{C}$
T_{stg}	storage temperature		-40		125	$^\circ\text{C}$
V_{ISOL}	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			2500	V~
M_d	mounting torque	(M4)	2.0		2.2	Nm
d_s	creep distance on surface		12.7			mm
d_A	strike distance through air		12.7			mm
Weight				40		g

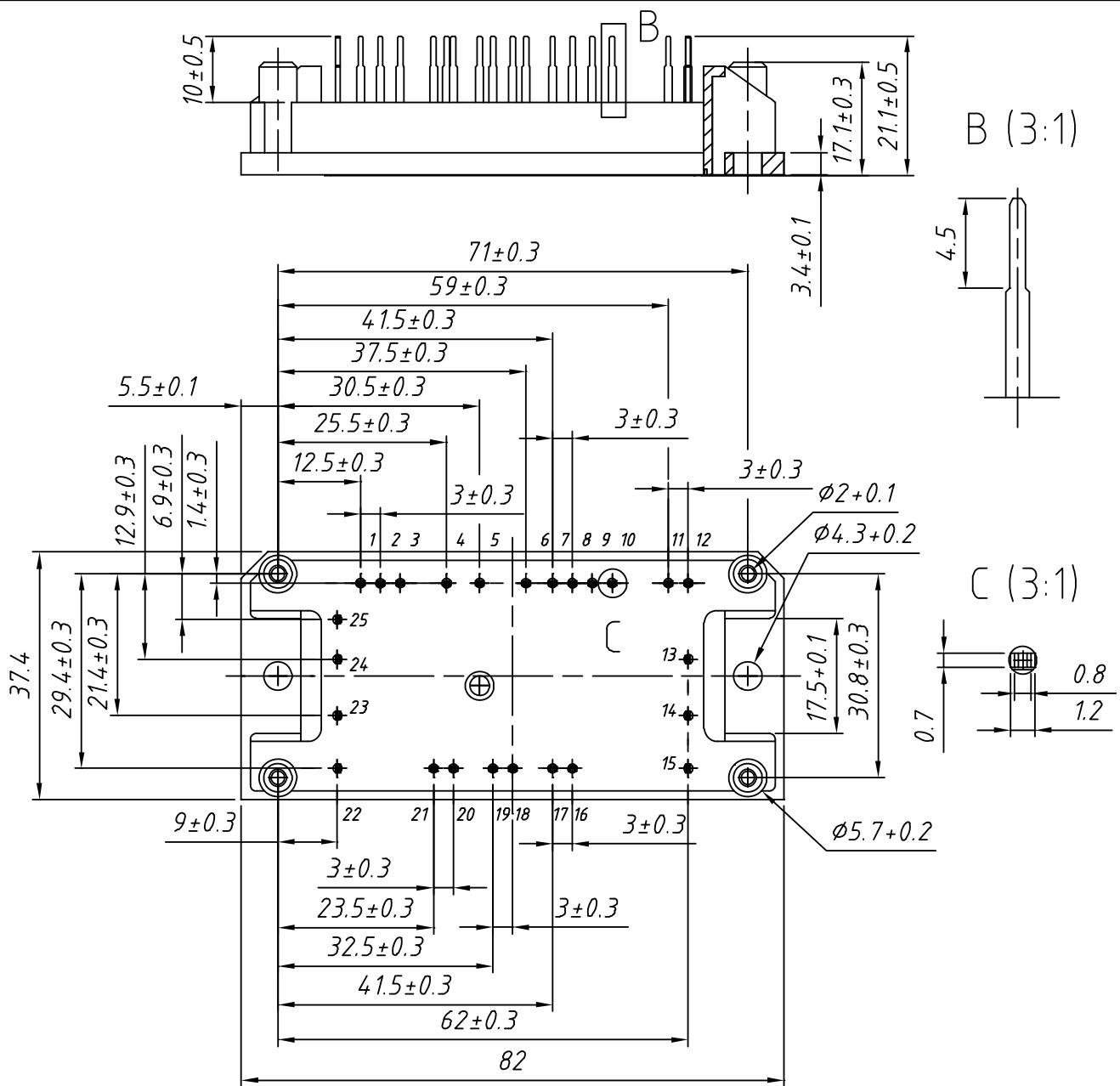
Equivalent Circuits for Simulation

	Ratings				
Symbol	Definitions	Conditions	min.	typ.	
V_0	rectifier diode	D8 - D13	$T_{VJ} = 125^\circ\text{C}$	0.90 12	$\text{m}\Omega$
R_0					
V_0	IGBT	T1 - T6	$T_{VJ} = 125^\circ\text{C}$	1.0 70	$\text{m}\Omega$
R_0					
V_0	free wheeling diode	D1 - D6	$T_{VJ} = 125^\circ\text{C}$	1.25 13	$\text{m}\Omega$
R_0					
V_0	IGBT	T7	$T_{VJ} = 125^\circ\text{C}$	1.4 150	$\text{m}\Omega$
R_0					
V_0	free wheeling diode	D7	$T_{VJ} = 125^\circ\text{C}$	1.25 26	$\text{m}\Omega$
R_0					

 $T_c = 25^\circ\text{C}$ unless otherwise stated

Outline Drawing

Dimensions in mm (1 mm = 0.0394")



Product Marking

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MUBW 20-06A6K	MUBW20-06A6K	Box	10	500 103